



Low Profile and High Efficiency 868 MHz ISM Band Loop Antenna

Part No:

ILA.02

Description:

868 MHz ISM Band Loop Antenna

Features:

Small size antenna, low profile, and high efficiency 868 MHz ISM Band 1 dBi Peak Gain 10 x 3.2 x 0.5 mm size SMT Compatible



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1. Introduction



The ILA.02 is a 868 MHz ISM band antenna featuring an excellent efficiency of 60% across the band. This antenna works the best when placed at the center of the board edge. The antenna, at $10 \times 3.2 \times 0.5$ mm, is low profile and would be suitable for devices with space constraints. The ILA.02 is delivered on tape and reel and now allows M2M customers to use an omni-directional SMT antenna. The omni-directional radiation characteristics allow for excellent performance regardless of device orientation. This is especially useful for devices that are not fixed in one particular spot during use. When there is little PCB space available for antenna placement, but high performance is required, the ILA.02 is the ideal choice.

This antenna can be mounted with no performance degradation in either orientation as long as the antenna is soldered correctly via Surface mounting. Please see the integration instructions section for further detail regarding the optimum way to integrate this antenna into your device.

For further optimization to customer-specific device environments and for support to integrate and test this antennas performance in your device, contact your regional Taoglas Customer Services Team.

Applications:

Automated Meter Reading (AMR)
Radio Frequency Identification (RFID)
Remote Monitoring
Healthcare
Sensing
868 MHz Applications



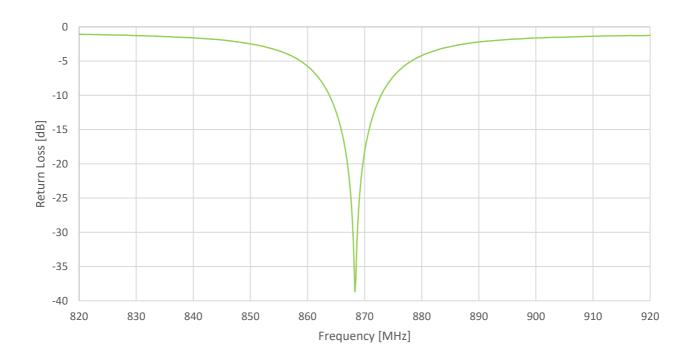
2. Specifications

Antenna					
Frequency (MHz)	868-870 MHz (ISM)				
	Efficiency (%)				
80 x 40 mm Ground Plane	55 (typical)				
	Average Gain (dB)				
80 x 40 mm Ground Plane	-2.5 dB				
	Peak Gain (dBi)				
80 x 40 mm Ground Plane	1 dBi				
Max Return Loss (dB)	-37 dB				
VSWR	2:1				
Impedance (Ω)	50Ω				
Polarization	Linear				
Radiation Pattern	Omni				
Input Power(W)	5				
	Mechanical				
Dimensions (mm)	10 x 3.2 x 0.5				
Required Space (mm)	11 x 10.4				
Material	Ceramic				
EVB Connector	SMA(F)				
	Environmental				
Temperature Range	-40°C to 85°C				
Storage Temperature	-40°C to 105°C				
Humidity	40% to 95%				
Moisture Sensitivity Level	3 (168 Hours)				

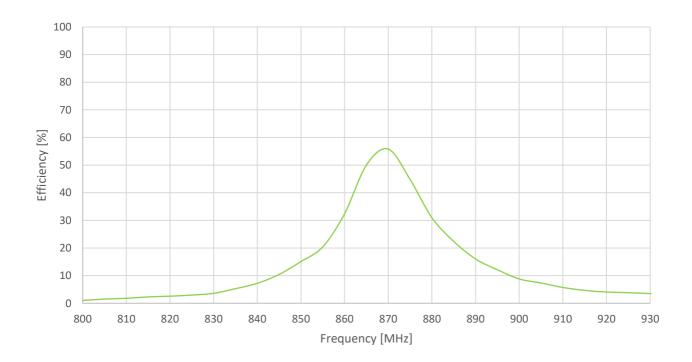


3. Antenna Characteristics

3.1 Return Loss

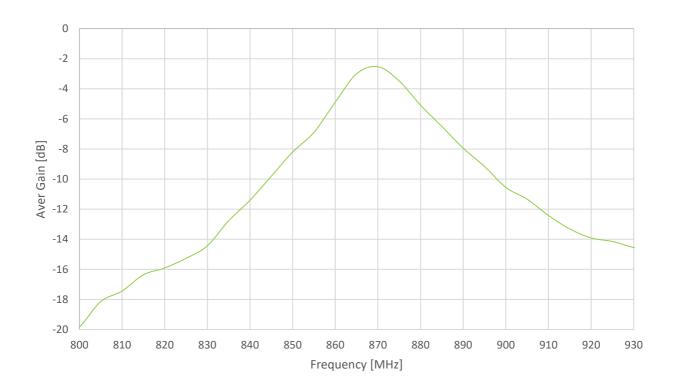


3.2 Efficiency

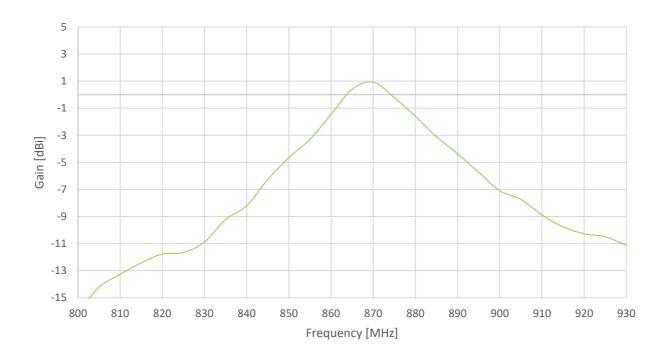




3.3 Average Gain

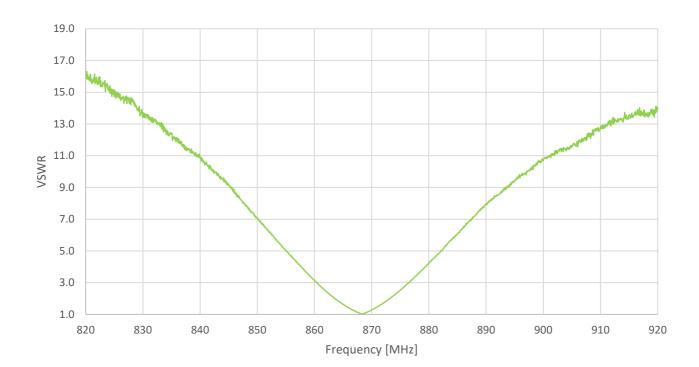


3.4 Peak Gain





3.5 VSWR

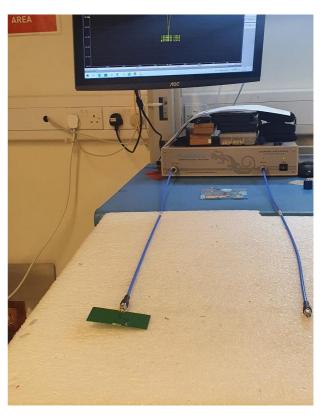




4. Radiation Patterns

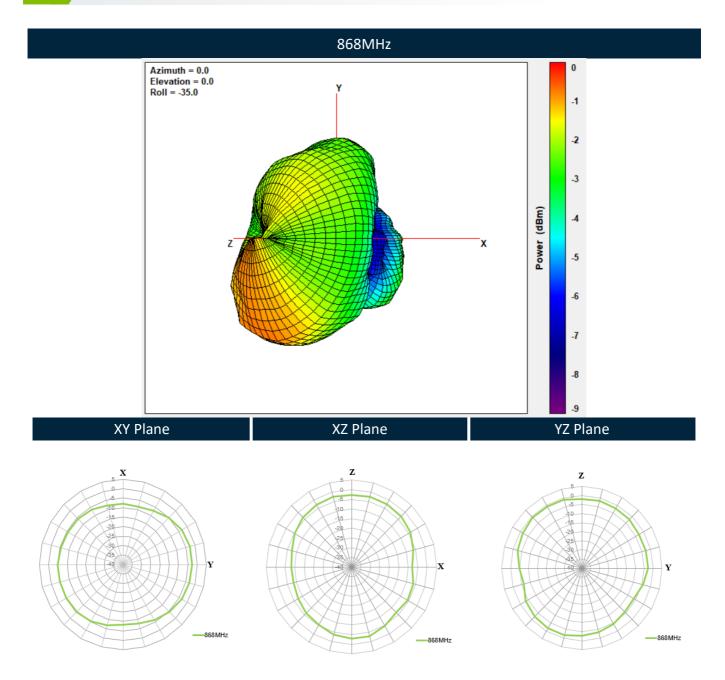
4.1 Test Setup – Antenna on Evaluation Board







4.3 2D&3D Radiation Pattern

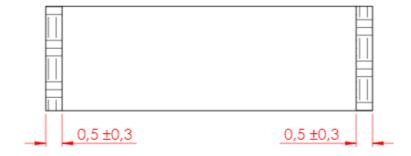


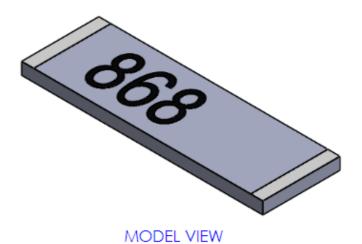


Mechanical Drawing – Antenna





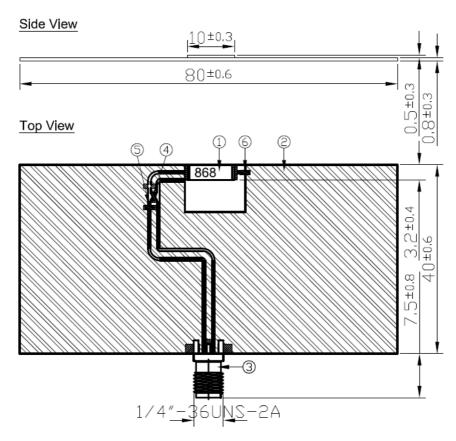


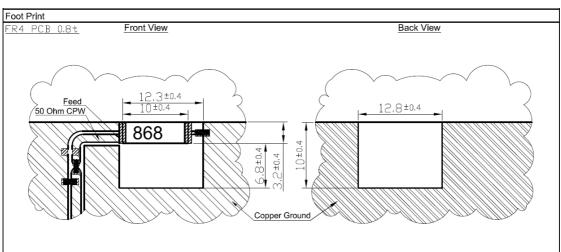


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Mechanical Drawing – Evaluation Board





NOTES:

- 1. Solder Area
- 2. Logo & Text Ink Printing : Black
 3. Copper
- 4. Matching Component
- 5. Component 6 is the tuning element of this antenna. 🙉

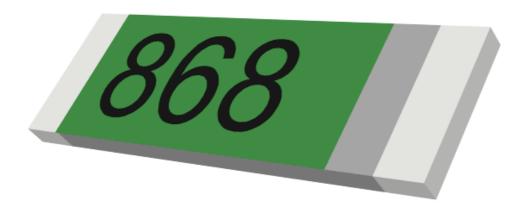
	Name	P/N	Material	Finish	QTY
1	ILA.02 Antenna	001513C000012A	Ceramic	N/A	1
2	ILA EVB Board	100213F000012A	FR4 0.8t	Green	1
3	SMA(F) ST	200413F000012A	Brass	Gold	1
4	Resistor 0Ω (0402)	001511J010012A	Ceramic	N/A	1
5	Capacitor 5pF (0402)	001514F030012A	Ceramic	N/A	1
6	Capacitor 15pF (0402)	001514F040012A	Ceramic	N/A	1

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7. Antenna Intergration Guide



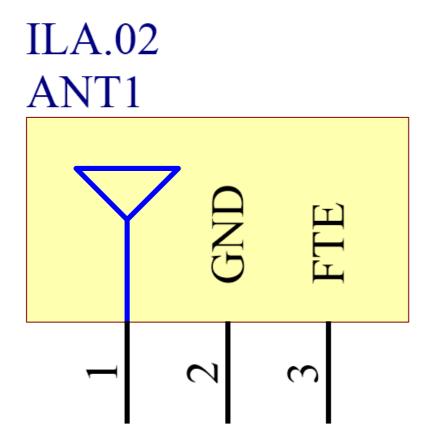




7.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 3 pins with only three pins as functional.

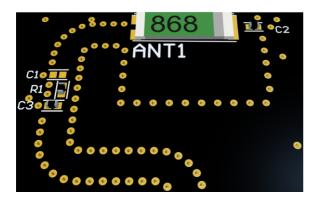
Pin	Description	
1	RF Feed	
2	Ground	
3	FTE	

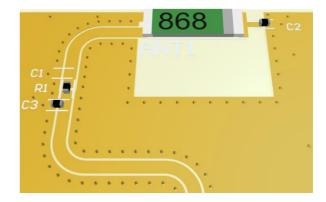




7.2 Antenna Integration

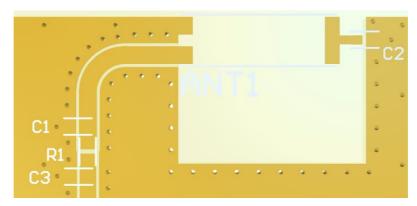
Whatever the size of the PCB, the antenna should ideally be placed on the PCB's longest side, to take advantage of the ground plane. Optimized matching components can be placed as shown.



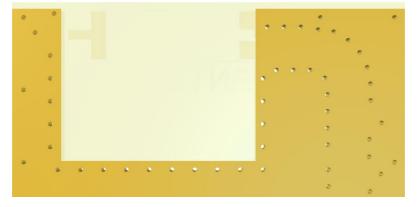


7.3 PCB Layout

The footprint and clearance on the PCB must meet the antenna specification. An example of the PCB layout shows the antenna footprint with clearance. Note the placement of the component C2. C2 is connected to Pin 3 of the antenna and helps with fine-tuning of the antenna. Further, note the placement of the additional components C1, R1, C3. These form a pi-matching network to help with matching the antenna in its final environment.



Topside

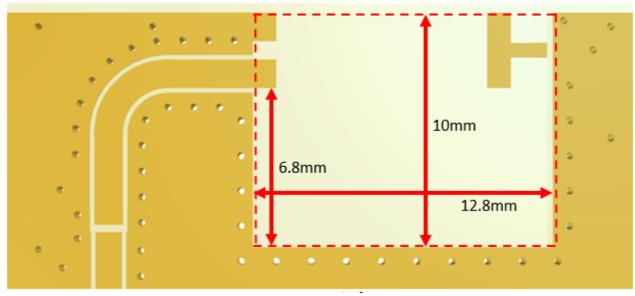


Bottom Side

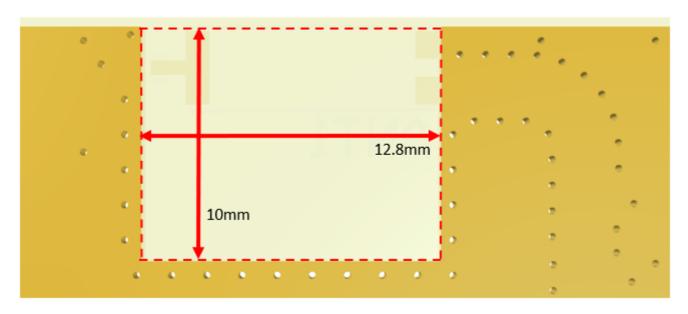


7.4 PCB Clearance

Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 10mm in length & 12.8mm in width. This clearance area includes the bottom side and ALL internal layers on the PCB.

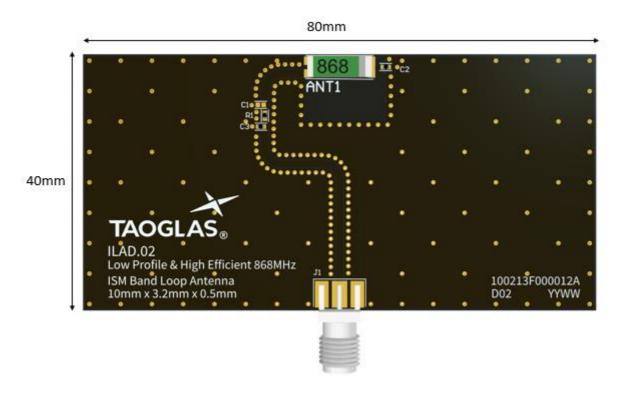


Topside

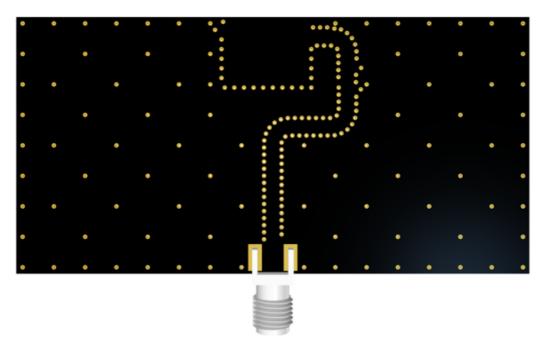


Bottom Side

7.5 Evaluation Board



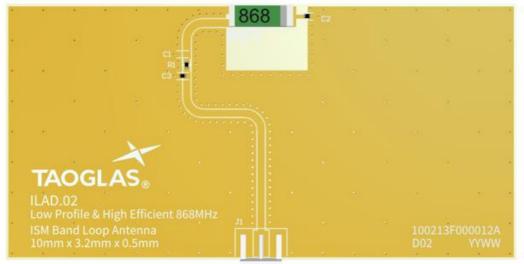
Topside



Bottom Side



Z.6 Evaluation Board Ground Plane Length



Ground Plane Length 40mm

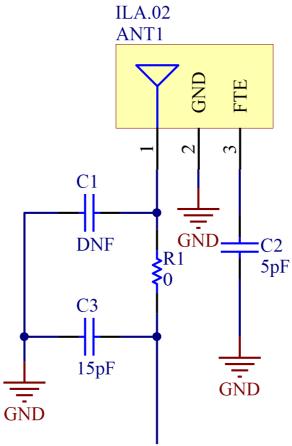
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7.7 Evaluation Board Matching Circuit

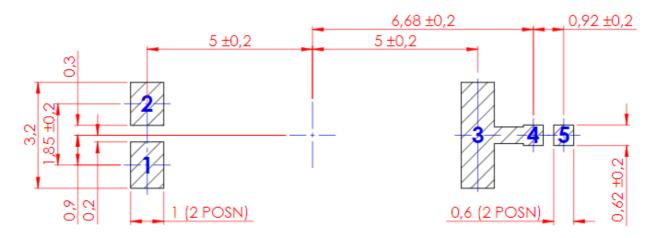
Matching components for the ILA.02 are required for the antenna to have optimal performance on the evaluation board, located outside of the copper clearance in the space specified in the above images. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the radio module and the antenna.



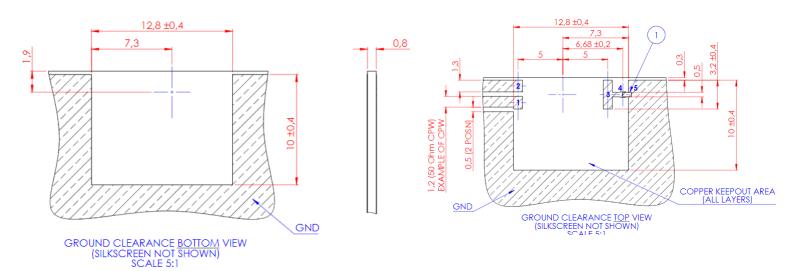
Designator	Туре	Value	Manufacturer	Manufacturer Part Number
R1	Resistor	0 Ohms	Yageo	RC0402FR-070RL
C1	Capacitor	Not Fitted	-	-
C2	Capacitor	5pF	Murata	GRM1555D1H5R6DA01D
C3	Capacitor	15pF	Murata	GRM1555C1H150JA01D

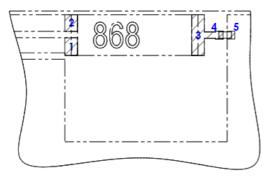


7.8 Footprint



FOOTPRINT PCB





FOOTPRINT SOLDER PADS WITH PCB OUTLINE SCALE 5:1

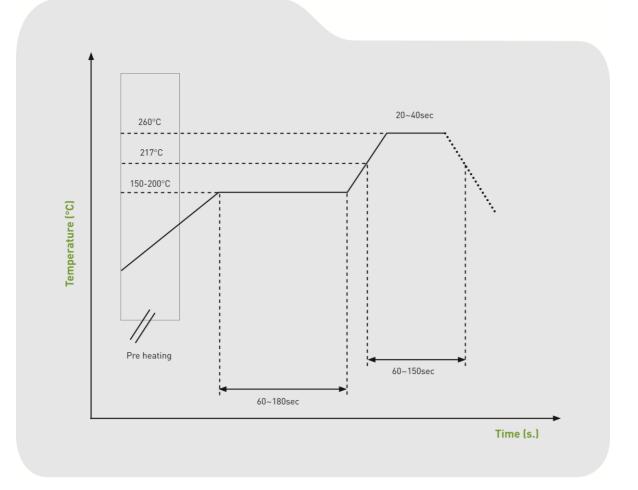
PIN:	DESCRIPTION:
1	RF FEED (50 Ohm)
2	GROUND
3	FINE-TUNING ELEMENT
4/5	FINE-TUNING COMPONENT

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8. Soldering Reflow Profile

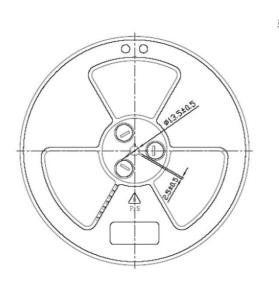
Typical Soldering profile for lead-free process:

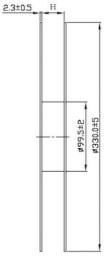




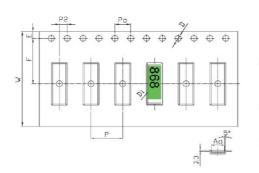
9. Packaging

6000 pcs ILA.02 reel Dimensions - 420*380mm Weight -1030g









Feature	Specifications	Tolerances
W	24.00	±0.30
Р	8.00	±0.10
E	1.75	±0.10
F	11.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10
		0.00
D1	1.50	±0.10
Po	4.00	±0.10
10Po	40.00	±0.20

Pocket Dim	ensions(unit: mm)	
Feature	Specifications	Tolerances
Ao	3.40	±0.10
Во	10.20	±0.10
Ko	0.70	±0.10
t	0.30	±0.05

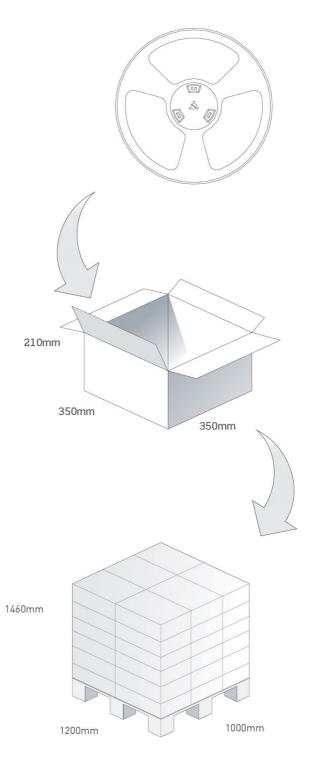
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6000 pcs ILA.02 reel Dimensions - 420*380mm Weight -1030g

6 reels, 36000pcs in one carton Carton Dimensions - 350*350*210mm Weight - 7Kg

Pallet Dimensions 1200*1000*1460mm 36 Cartons per Pallet 6 Cartons per layer 6 Layers





Changelog for the datasheet

SPE-12-8-080- ILA.02

Revision: H (Current Version)		
Date:	2022-06-23	
Changes:	Updated graphs , radiation patterns and Antenna Installation Guide	
Changes Made by:	Evan Murphy	

Previous Revisions

Revision: G (Current Version)		
Date:	2021-10-28	
Changes:	Format Change, MSL	
Changes Made by:	Erik Landi	

Revision: B	
Date:	2012-06-27
Changes:	
Changes Made by:	STAFF

Revision: F		
Date:	2017-10-23	
Changes:	Packing drawing updated	
Changes Made by:	Carol Faughnan	

Revision: A (Original First Release)		
Date:	2012-05-08	
Notes:	Initial Release	
Author:	STAFF	

Revision: E	
Date:	2017-04-21
Changes:	
Changes Made by:	STAFF

Revision: D		
Date:	2016-09-12	
Changes:		
Changes Made by:	STAFF	

Revision: C		
Date:	2014-08-19	
Changes:	EVB & Footprint	
Changes Made by:	AINE DOYLE	



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